

# ELECTRONIC INFORMATION DISCLOSURE STATEMENT NOV 17 2000 TC 17 2000

Electronic Version v18 Stylesheet Version v18.0

> Title of Invention

MICROMACHINED STRUCTURES MADE BY COMB WET AND DRY ETCHING

**Application Number:** 

10/076858

Confirmation Number:

8738

First Named Applicant:

Dan Steinberg

Attorney Docket Number: Shipley 03-19

Art Unit:

1775

Examiner:

Stephen J. Stein

Search string:

( 4225213 or 4253735 or 4362367 or 4411057 or 4812002 or 4830450 or 5024500 or 5095386 or 5135590 or 5281301 or 5357593 or 5381231 or 5844723 or 5896481 or 5911021 or 6023546

or 6088168 or 20030067049 ).pn.

#### **US Patent Documents**

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
223	1	4225213	1980-09-30	McBride, Jr. et al.			
555	2	4253735	1981-03-03	Kawamura et al.			
22.2	3	4362367	1982-12-07	Hammer et al.			
221	4	4411057	1983-10-25	Duda et al.			
Sss	5	4812002	1989-03-14	Kato et al.			
55	6	4830450	1989-05-16	Connell et al.	;		
SIS	7	5024500	1991-06-18	Stanley et al.			
535	8	5095386	1992-03-10	Scheibengraber			
551	9	5135590	1992-08-04	Basavanhally et al.			
535	10	5281301	1994-01-25	Basavanhally			,
555	11	5357593	1994-10-18	Bossler			
533	12	5381231	1995-01-10	Tu			
SAS	13	5844723	1998-12-01	Snyder			
573	14	5896481	1999-04-20	Beranek et al.			
535	15	5911021	1999-06-08	MacDonald et al.			

550	16	6023546	2000-02-08	Tachigori
555	17	6088168	2000-07-11	Snyder

# **US Published Applications**

Note: Applicant is not required to submit a paper copy of cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
53 9	1	20030067049	2003-04-10	Steinberg et al.			

### Remarks

Note: Remarks are not for responding to an office action.

In the event a fee is required the Commissioner is authorized to charge any underpayment or credit any overpayment to the account of the undersigned attorneys, Account No. 04-1406.

# Signature

Examiner Name		Dațe
Style Stem.	5/1	104

# **ELECTRONIC INFORMATION DISCLOSURE STATEMENT**

Electronic Version v18 Stylesheet Version v18.0

> Title of Invention

MICROMACHINED STRUCTURES MADE BY COMBINED **EXEL** AND DRY ETCHING

**Application Number:** 

10/076858

Confirmation Number:

8738

First Named Applicant:

Dan Steinberg

Attorney Docket Number: Shipley 03-19

Art Unit:

1775

Examiner:

Stephen J. Stein

Search string:

( 4021097 or 4181400 or 4601541 or 4683560

or 5339377 or 5440657 or 5781675 or 5966493

or 6212320 or 6511235 or 6548371 or

6553173 ).pn.

## **US Patent Documents**

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
53,	1	4021097	1977-05-03	McMahon			
585	2	4181400	1980-01-01	Malsot et al.			
555	3	4601541	1986-07-22	Shaw et al.			
55	4	4683560	1987-07-28	Takeuchi et al.			
535	5	5339377	1994-08-16	Takahashi			
57	6	5440657	1995-08-08	Essert			•
555	7	5781675	1998-07-14	Tseng et al.			
525	8	5966493	1999-10-12	Wagoner et al.			
555	9	6212320	2001-04-03	Rickman et al.			
555	10	6511235	2003-01-28	Wu et al.			
535	11	6548371	2003-04-15	Fujimaki			
535	12	6553173	2003-04-22	Goto			

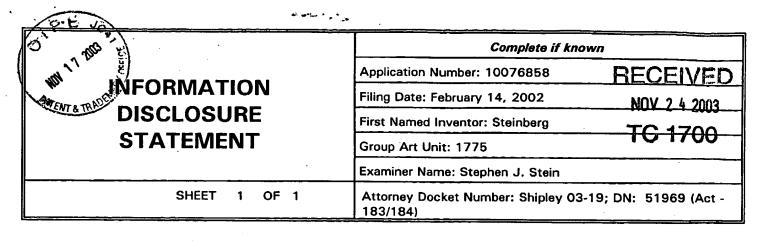
#### Remarks

Note: Remarks are not for responding to an office action.

In the event a fee is required the Commissioner is authorized to charge any underpayment or credit any overpayment to the account of the undersigned attorneys, Account No. 04-1406.

Signature

Examiner Name	Date
Auf Str	5/1/04



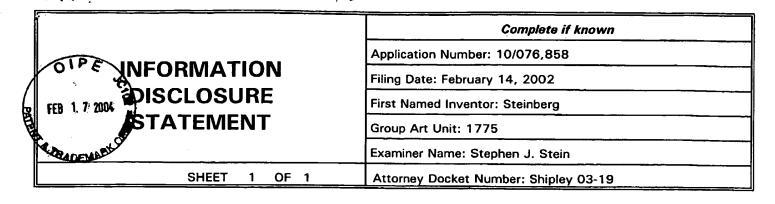
UNITED STATES PATENT DOCUMENTS								
EXAMINER'S INITIALS	CITE NO.	PATENT NUMBER	ISSUE DATE MM-DD-YYYY	FIRST NAMED INVENTOR				

FOREIGN PATENT DOCUMENTS								
EXAMINER'S INITIALS	CITE NO.	DOCUMENT NUMBER	COUNTRY OR REGION	DATE OF PUBLICATION MM-DD-YYYY	FIRST NAMED INVENTOR OR APPLICANT			

	OTHER PRIOR ART - NON-PATENT DOCUMENTS						
EXAMINER'S INITIALS	CITE NO.	Include name of the author (in Capital Letters), title of the article (when appropriate), title of the item(book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published					
227		J. G. Fleming, "Combining the best of bulk and surface micromachining using Si {111} substrates." SPIE Vol. 3511, September 1998, pp. 162-168.					
227		J. Brugger, et al., "Self-aligned 3D shadow mask technique for petterning deeply recessed surfaces of micro-electo-mechanical systems devices." Sensors and Actuators 76 (1999) pp. 329-334.					

EXAMINER'S SIGNATURE	Stylen	Sten.	DATE CONSIDERED	5/1/04

**EXAMINER:** Initial if reference considered, whether or not citation is in conformance with MPEP \$609. Draw a line through citation if citation not in conformance and reference not considered. Include a copy of this form with next communication to applicant.



UNITED STATES PATENT DOCUMENTS							
EXAMINER'S INITIALS	CITE NO.	PATENT NUMBER	ISSUE DATE MM-DD-YYYY	FIRST NAMED INVENTOR			
5ৱ5		4706061	11/10/1987	Johnson			
SIS		4784721	11/15/1988	Holmen et al.			
525		4837129	06/06/1989	Frisch et al.			
503		4945400	07/31/1990	Blonder et al.			
5.22		5384872	01/24/1995	Jacobs-Cook et al.			
SSS		5760305	06/02/1998	Greiff			

FOREIGN PATENT DOCUMENTS								
EXAMINER'S INITIALS	CITE NO.	DOCUMENT NUMBER	COUNTRY OR REGION	DATE OF PUBLICATION MM-DD-YYYY	FIRST NAMED INVENTOR OR APPLICANT			
222.		WO 03/008139	wo	01/30/2003	Steinberg et al.			

OTHER PRIOR ART - NON-PATENT DOCUMENTS					
EXAMINER'S CITE Include name of the author (in Capital Letters), title of the article (when appropriate), title of the item(book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published					
222		Marc Madou, "Fundamentals of Microfabrication", CRC Press, pp. 174-178, 1997. (ルゥ ハンジト)			

EXAMINER'S SIGNATURE	Styr Ste CONSIDERED	5/	1/2004
	•		<u> </u>

**EXAMINER:** Initial if reference considered, whether or not citation is in conformance with MPEP §609. Draw a line through citation if citation not in conformance and reference not considered. Include a copy of this form with next communication to applicant.